

Att r n y Dock t No. 50626.54**DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **IMPROVED BALL GRID ARRAY PACKAGE AND PROCESS FOR MANUFACTURING SAME** the specification of which is attached hereto unless the following box is checked:

☒ was filed on August 25, 2003 as United States Application Number 10/647,696 or PCT International Application Number \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)		Priority Date	Priority Claimed	
(Number)	(Country) (PCT)	(Day/Month/Year Filed)	Yes	No
_____	_____	_____	___	___

  

Prior Foreign Application(s)		Priority Date	Priority Claimed	
(Number)	(Country) (PCT)	(Day/Month/Year Filed)	Yes	No
_____	_____	_____	___	___

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

_____	_____
(Application Number)	(Filing Date)
_____	_____
(Application Number)	(Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to

patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

<u>10/643,961</u> (Application Number)	<u>August 20, 2003</u> (Filing Date)	<u>pending</u> (Status-patented, pending, abandoned)
<u>10/323,657</u> (Application Number)	<u>December 20, 2002</u> (Filing Date)	<u>pending</u> (Status-patented, pending, abandoned)
<u>10/197,832</u> (Application Number)	<u>July 19, 2002</u> (Filing Date)	<u>pending</u> (Status - patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Joseph R. Keating, Reg. No. 37,368

Address all correspondence to:

Joseph R. Keating, Esq.  
Keating & Bennett LLP  
10400 Eaton Place, Suite 312  
Fairfax, VA 22030  
(703) 385-5200

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor (given name, family name) Mohan KIRLOSKAR

Inventor's signature  Date 8 Oct 03

Residence 7712 Oak Meadow Court, Cupertino, California, U.S.A. 95014 Citizenship U.S.A.

Post Office Address Same as above

Full name of second inventor (given name, family name) Chun Ho FAN

Inventor's signature  Date Sept 23, 03

Residence Flat E, 27/F, Blk 3, Lido Garden, Sham Tseng, New Territories, Hong Kong  
Citizenship British National Overseas

Post Office Address Same as above

Full name of third inventor (given name, family name) Neil McLELLAN

Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_

Residence 110 Woodranch Cr., Danville, California, U.S.A. 94506 Citizenship U.S.A.

Post Office Address Same as above

patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

<u>(Application Number)</u>	<u>August 20, 2003</u> (Filing Date)	<u>pending</u> (Status-patented, pending, abandoned)
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Full name of first inventor (given name, family name) Mohan KIRLOSKAR

Inventor's signature Alan K. Kohn Date 1/13/04

Residence 7712 Oak Meadow Court, Coopertino, California, U.S.A. 95014, Citizenship U.S.A.

Post Office Address Same as above

Full name of second inventor (given name, family name) Chun Ho FAN

Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_

Residence Flat E, 27/F, Blk 3, Lido Garden, Sham Tseng, New Territories, Hong Kong.  
Citizenship British National Overseas

Post Office Address Same as above

Full name of third inventor (given name, family name) Neil McLELLAN

Inventor's signature [Signature] Date 1/13/09

Residence 110 Woodranch Cr., Danville, California, U.S.A. 94506, Citizenship U.S.A.

Post Office Address Same as above